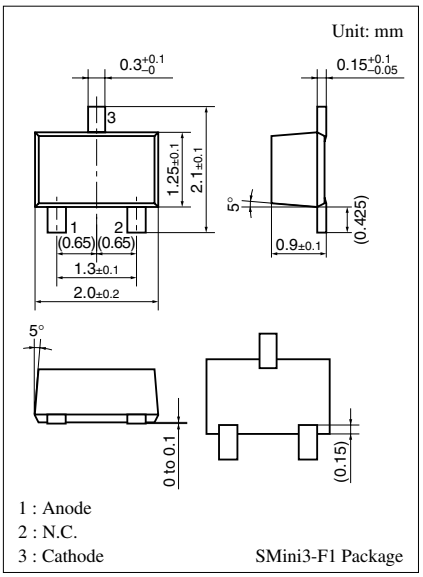
MA3ZD12

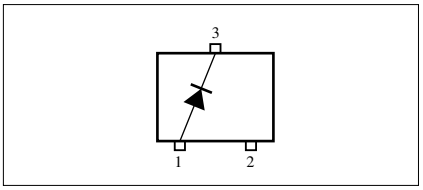
Silicon epitaxial planar type

For high speed switching



Marking Symbol: M5E

Internal Connection



■ Features

- $I_{F(AV)}$ = 700 mA rectification is possible
- Low forward voltage: V_F < 0.45 V
- High-density mounting is possible
- S-Mini type 3-pin package

■ Absolute Maximum Ratings T_a = 25°C

Parameter	Symbol	Rating	Unit
Reverse voltage (DC)	V_R	20	V
Repetitive peak reverse-voltage	V_{RRM}	25	V
Average forward current *2	$I_{F(AV)}$	700	mA
Non-repetitive peak forward-surge-current *1	I_{FSM}	2	A
Junction temperature	T_j	125	°C
Storage temperature	T_{stg}	−55 to +125	°C

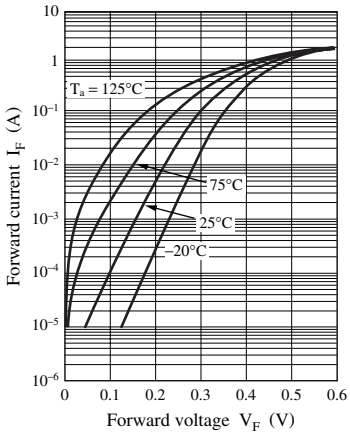
Note) ∗1: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)
∗2: Mounted on a alumina PC board

■ Electrical Characteristics T_a = 25°C ± 3°C

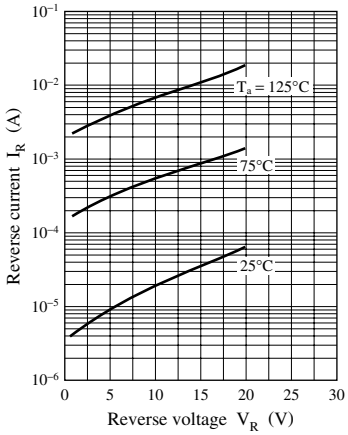
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse current (DC)	I_R	V_R = 20 V			200	µA
Forward voltage (DC)	V_F	I_F = 700 mA			0.45	V
Terminal capacitance	C_t	V_R = 0 V, f = 1 MHz		100		pF
Reverse recovery time	t_{rr}	$I_F = I_R$ = 100 mA I_{rr} = 10 mA, R_L = 100 Ω		7		ns

Note) 1. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
2. Rated input/output frequency: 250 MHz

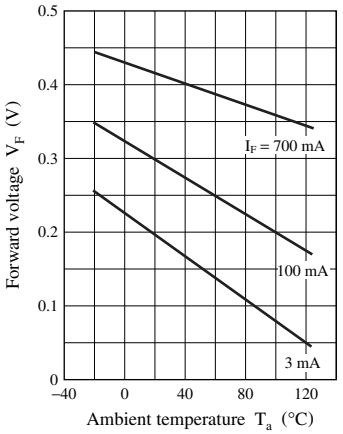
I_F — V_F



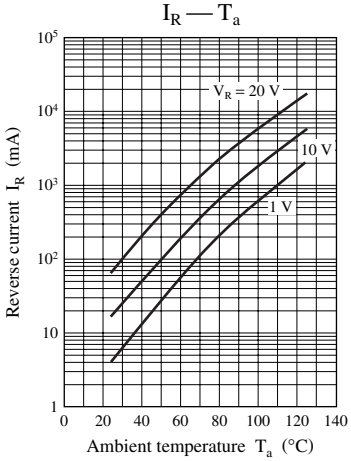
I_R — V_R



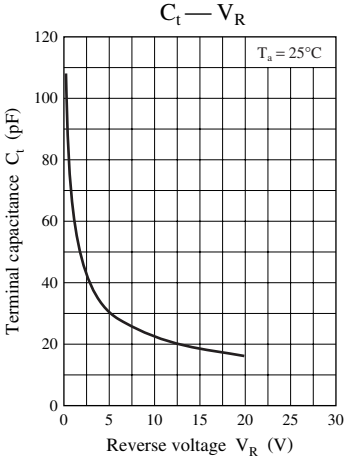
V_F — T_a



I_R — T_a



C_t — V_R



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